Microstructural and wear characterizations of Ultra-Dispersed Diamond (UDD) reinforced Cu-15 wt.% Ti composites fabricated via mechanical alloying and sintering

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Abstract

In this study, effects of ultra-dispersed nanodiamond content on the microstructure and wear properties of Cu-15 wt.% Ti matrix composite were investigated. Samples were prepared by mechanical alloying and sintering at 890°C for 2 h under H2 gas atmosphere. Microstructural changes and dry sliding wear characterizations of sintered samples were investigated by a field emission scanning electron microscope (FESEM), and their phase characteristics were carried out using X-ray diffractometer (XRD). Electron microscopy investigations revealed that a good bonding between nanodiamond particles and Cu matrix could not be maintained due to the formation of free copper layers and the presence of high oxygen amount at the interface. The results taken from worn surfaces showed that high content of nanodiamond (10 wt.%) with oxide particles led to low wear resistance due to poor bonding between Cu-15 wt.% Ti matrix and nanodiamond particles which were pulled out during dry sliding wear.

Key words: ultra-dispersed nanodiamond powders, microstructure, wear resistance

1. Introduction

Copper has an excellent electrical conductivity at high temperatures (up to 800°C) as well as excellent thermal conductivity and corrosion resistance. However, low abrasion and wear resistance of copper limit its use in many other applications [1]. These limitations are often circumvented by dispersing a stronger ceramic material in the copper matrix. In the literature, Al2O3 [2, 3], NbC [4], Fe3C [5], SiC [6], diamond [7–9] have commonly been used as reinforcements for Cu matrix. Among these, nanodiamond particles are quite attractive due to their unique mechanical and tribological properties, including extreme hardness and inertness to chemical attack [10–12]. In recent years, several attempts have been made in utilizing nanodiamond particles as reinforcement in the Al [13, 14], Ni, and Fe matrices [15] owing to their high surface energy which allows an effective structure interaction with utilized matrices. Advantages can be taken from extremely high surface areas, surface charges and self-lubrication [16, 17] properties of diamond nanoparticles and the ductility of the copper matrix, obtaining a composite with mechanically strong material. However, a homogeneous distribution and good interfacial bonding of the reinforcement with the matrix are required for improving the mechanical and wear properties of the composites. Many efforts have been made to investigate thermal and physical properties of diamond reinforced Cu composites fabricated by using different techniques such as casting [8] and powder metallurgy route involving the mixing and conventional sintering [7], pressureless sintering [18], ball milling and spark plasma sintering [19], hot pressing [20]. Thanks to bonding between diamond particles and Cu matrices, some active elements such as Ti, B, Cr, and Zr have been added to improve the interface associated with precipitation of some intermetallic phases such as Cu3Ti, Cu2Ti, TiB2, TiC, etc. [8, 21–23]. It was reported [8, 9] that the strong bonding between diamond and copper was obtained with the addition of Ti and this led to heat and load transfer

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increment. Titanium was used as an interfacial binder in a number of studies in order to improve the interfacial bonding strength between the copper matrix and SiC [24, 25], diamond [26].

The amount of published literature on nanodiamond reinforced copper matrix alloys is rather limited and primarily concerned with electronic applications of these composites. There are also some reported investigations on the utilization of nanodiamond particles as reinforcement in Cu matrix composites [20, 27, 28]. In these investigations, the difficulties in obtaining well-structured composites arising from both homogeneous dispersion of nanodiamond and deficient bonding between diamond and copper were explained [20, 28]. In all studies, Cu phase is not alloyed with a transition metal, and it is utilized as a pure matrix phase. Thus, there is still a lack of knowledge in the archival literature regarding Cu-based alloys reinforced with nanodiamond particles. The present study aims to fulfil this gap. In the present investigation, Cu pre-alloyed with 15 wt.% Ti was used as a matrix and different amounts of nanodiamond particles (1 and 10 wt.%) were incorporated using high energy ball milling. Microstructural changes and wear characteristics of sintered composites were evaluated as a function of the nanodiamond content.

2. Experimental procedure

Elemental electrolytic copper (Cu) (Alfa Aesar®TM, 99 % purity, –325 mesh), titanium (Alfa Aesar®TM, 99.5 % purity, –325 mesh), and ultra-dispersed nanodiamond (UDD) (ALIT Co., up to 99.5 % pure diamond, average size 50 nm) powders were used in the present investigation. The detailed information about UDD powders was presented in our previous work [13]. In this study, in order to improve the bonding between Cu and UDD particles, 15 wt.% Ti was added to the Cu matrix [26]. Cu and Ti powders were blended to constitute the composition Cu-15 wt.% Ti (hereafter referred to as Cu15Ti). As-blended powders were mechanically alloyed (MA’d) for 120 min in a high energy ball mill (Spex®TM 8000D, New Jersey, USA) with a speed of 1200 rpm using a steel vial with steel balls having a diameter of 6.36 mm. To prevent oxidation during MA process, the vials were sealed inside a Plaslabs®TM glove box under purified Ar gas (99.995 % purity). The ball-to-powder weight ratio (BPR) was 7:1. 1 wt.% stearic acid was used as a process control agent (PCA) to inhibit cold-welding and agglomeration during MA. The mean particle size of pre-alloyed Cu15Ti powders was 7.9 ± 1.2 μm. 1 and 10 wt.% of ultra-dispersed nano-diamond (UDD) powders were added to Cu15Ti alloy powders. Powder blends having the compositions of Cu-15 wt.% Ti-1 wt.% UDD and Cu-15 wt.% Ti-10 wt.% UDD (hereafter referred to as Cu15Ti/1 UDD and Cu15Ti/10 UDD, respectively) were further MA’d for 120 min using the same conditions. In the present study, on the basis of MA runs for different durations, an optimum milling time of 120 min was chosen to achieve the milling efficiency and restrict the contamination from the milling media. Thermal investigations were carried out in a differential scanning calorimeter (DSC) (TA®TM, New Castle, USA). Samples of ∼7 mg contained in α-alumina crucible were heated up to 900 °C with a heating rate of 10 °C min⁻¹. During the heating process, a mixture of 96 vol.% Ar and 4 vol.% H₂ gases were introduced into the furnace at a flow rate of 30 and 5 ml min⁻¹, respectively.

Mechanically alloyed powders were cold pressed uniaxially using a constant pressure of 200 MPa in a steel mold to form a 12 mm cylindrical compact. The compacts were sintered at 890 °C in a furnace (Unitherm®TM 1161V, Pittsburg, USA) for 2 h. Figure 1 gives the detailed thermal profile and atmospheres used in the sintering process.

Microstructural and phase characteristics of sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composite samples were conducted by using X-ray Diffractometry (XRD) and Scanning Electron Microscopy (SEM) techniques. A Bruker®TM D8 Advance XRD was used with a standard Cu Kα radiation source employing a step size of 0.02° in 2θ. The sintered samples were ground manually using SiC papers. After grinding, the alloyed powders and sintered samples were polished using 0.3 μm Al₂O₃ powders on a soft cloth prior to XRD analyses. The sintered samples were mechanically broken into pieces in both longitudinal and transverse directions to allow for the investigation of the fracture surfaces. A Jeol®TM JSM 7000F field emission scanning electron microscope (FESEM) operating at a voltage of 15 kV equipped with an IXRF®TM energy dispersive spectrometer (EDS) was used to assess sur-
face morphology and fracture surface of the sintered composites as well as their qualitative chemistry. Prior to SEM investigations, polished samples were etched in a solution ammonium (NH₄OH) (20 ml), hydrogen peroxide (H₂O₂) (8 ml), and distilled water (20 ml) [29]. Vickers microhardness tests on sintered samples were conducted using a Shimadzu™ microhardness tester under a load of 100 g for 10 s. Sliding wear experiments were conducted on a Tribotest™ Oscillating Tribotester using 1.587 µm steel balls (100 CR6-62 HRC) under an applied force of 2 N. The tests were conducted at room temperature in a laboratory atmosphere with a sliding speed of 10 mm s⁻¹, a stroke length of 5 mm and a sliding distance of 30 m. Worn surfaces were examined using the Jeol™ JSM 7000F FESEM operating at a voltage of 10 kV. Results of the wear tests were evaluated according to the volume of the material loss measured in a Veeco™ Dektak 6 M Stylus Profiler. Wear test results for each sample are the arithmetic mean of three different measurements.

3. Results and discussion

3.1. Phase identification and thermal analysis

Figure 2a shows the XRD patterns of the sintered Cu15Ti matrix alloy, Cu15Ti/1 UDD, and Cu15Ti/10 UDD composites. As seen in Fig. 2a, the reflections of Cu (Bravais lattice: face-centered-cubic (f.c.c.); Space group: Fm3m; a = 0.362 nm; ICDD PDF # 70-3038) and Ti (Bravais lattice: Hexagonal, Space group: P63/mmc; a = 0.295 nm, c = 0.4682 nm; ICDD PDF # 44-1294) can be observed in the XRD pattern of all the sintered samples. In addition to these phases, peaks belonging to diamond (Structure: A4 Diamond cubic; Space group: Fd3m; a = 0.356 nm; ICDD PDF # 65-0537) can be identified in the sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composites. A small reflection peak belonging to the CuO phase (Bravais lattice: base centered monoclinic; Space group: C2/c; a = 0.467 nm, b = 0.343 nm, c = 0.513 nm, β = 99.42°; ICDD PDF # 89-5895), as previously reported in the study of Fathima et al. [30] for Cu-oxide nanorods, is also present in the XRD patterns of the sintered Cu15Ti/10 UDD composite. It is evident that the reflections of copper show a remarkable intensity reduction and peak broadening with increasing nanodiamond content indicating crystallite size refinement as well as the accumulation of internal strain in copper. Contrary to the reported XRD results for the Cu-nanodiamond composites [20, 28], no impurities or contaminations originating from the milling media could be detected in the XRD analysis of Cu15Ti/1 UDD and Cu15Ti/10 UDD sintered samples (Fig. 2a).

In addition, no intermetallic phases were detected in the XRD patterns of sintered samples. However, patterns belonging to Cu/Ti reaction products such as CuTi, Cu₄Ti, Cu₄Ti₃, and Cu₄Ti₂ were observed in the XRD results of some reported literature [21, 22, 24, 31]. For instance, a weak Cu₄Ti peak was identified in the XRD analysis by Cheng et al. [31] who prepared Cu-15 wt.% Ti reinforced with diamond particles. Similarly, Shiu et al. [21] observed the CuTi₂, Cu₄Ti, and Cu₄Ti₃ intermetallics for the brazed Cu and Ti with silver-based alloy at 980°C. In addition, Xian et al. [24] claimed that the differences in the interfacial reaction products mainly depend on the fabrication temperature, time, and the thickness of Ti layer which diffused into Cu for coating experiments. Therefore, it is believed that emergence of these intermetallic phases may be due to a higher processing temperature than that was used in the present study (890°C).

In order to obtain useful information about struc-
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natural changes during solid-state sintering, a non-isothermal DSC analysis was performed on the Cu15Ti/10 UDD powders MA’d for 120 min. The DSC curve of the MA’d Cu15Ti/10 UDD powders given in Fig. 2b exhibits only an exothermic peak at 292°C belonging to the formation of a copper oxide phase. This confirms the XRD results obtained from sintered samples (Fig. 2a). Moreover, based on the DSC analysis and XRD investigations, the crystal structure of nanodiamond particles was preserved, and nanodiamond particles did not decompose into graphite after sintering at 890°C. In the present study, the exothermic peak observed in DSC analysis was similar to that recorded for copper oxide nanorods which were synthesized using different surfactant micelles [30]. Because of high oxygen affinity of Cu powders, high sintering temperatures and controlled atmospheres are both necessary to remove oxides from the powder surface. Thus, in the present study before the ball-milling process, the powder mixtures were loaded under Ar atmosphere and were sintered in H2 and N2 atmospheres (Fig. 1) to prevent the formation of any oxide impurities. However, XRD results of the sintered samples indicated the formation of the CuO phase after sintering process. Therefore, it can be suggested that the natural oxide layers covering the powders are difficult to be reduced during sintering even though required atmosphere with the high sintering temperature exist.

3.2. SEM investigations

Figure 3 shows the back-scattered SEM image of the Cu15Ti alloy and corresponding energy dispersive spectra (EDS) from bright (Fig. 3b) and dark (Fig. 3c) regions. EDS spectra revealed that dark regions are composed of Ti particles, whereas bright areas belong to the copper phase. These results are consistent with the XRD results in Fig. 2a. As shown in Fig. 3a, uniformly distributed porosities having sizes between 0.3 and 0.5 μm can be observed in the microstructure of the Cu15Ti matrix alloy. Figure 4 shows SEM im-

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Fig. 3. SEM images of (a) the Cu15Ti matrix alloy and corresponding EDS analyses taken from the (b) bright and (c) dark regions.

Fig. 4. SEM images of (a) the Cu15Ti matrix alloy and (b) the Cu15Ti/10 UDD composite.
ages of the sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composites. A significant microstructural difference was observed between the Cu15Ti matrix alloy (Fig. 3a), and the UDD reinforced Cu15Ti/1 UDD (Fig. 4a) and Cu15Ti/10 UDD (Fig. 4b) composites. As seen in the SEM micrograph of the Cu15Ti/1 UDD composite (Fig. 4a), frame-like bright regions are separated from grey regions, and their amounts increase in the Cu15Ti/10 UDD composite sample with increasing UDD content (Fig. 4b).

In order to identify the present phases and their distributions in the Cu15Ti/10 UDD composite, series of elemental maps were performed for the elements lines of C Kα, O Kα, Ti Kα, Cu Kα (Fig. 5). Figure 5a gives the detailed frame-like Cu-rich structures for the Cu15Ti/10 UDD composite sample. SEM image for the sintered Cu15Ti/10 UDD composite and corresponding EDS maps of the C, O, Ti, and Cu elements are given in Figs. 5b–e. Elemental EDS mappings of Ti and C in Fig. 5 indicate that the UDD particles and Ti
particles are uniformly distributed in the Cu15Ti/10 UDD sample. From Figs. 5c,e inter-lapping of O and Cu elements is noticeable on almost the entire surface of the sample except in the frame-like regions. As shown in Fig. 5e, Cu occupies the frame-like regions, and thus it can be suggested that these frame-like regions belong to the free Cu layer. Similar copper layers surrounding nanocrystalline regions of Cu and Al₂O₃ were reported by Hwang et al. [32] who studied the mecanochemical synthesis of nanocrystalline Al₂O₃ dispersed Cu composites. They suggested that these free copper layers were formed due to some unreacted copper powders after sintering [32]. Based on the EDS map analysis shown in Fig. 5b, well-distributed bright spots are assigned to UDD agglomerates.

In order to examine the changes in element distribution in the frame-like structure, the EDS line-scanning across the interface between the matrix and the Cu-rich zone of the Cu15Ti/10 UDD composite sample was carried out for copper, diamond, titanium, and oxygen, and this is given in Fig. 6. As in Fig. 6, the oxygen signal prominently exists at the interface between UDD particles and Cu-rich zone. The reaction layers which provide the strong bonding between diamond and matrix interface were not produced at the interface. These four profiles in Figure 6b show an inner layer rich in Cu and a Ti-free layer. In addition, an increase in Ti concentration in the matrix of Cu15Ti/10 UDD composite sample was observed from the line-scan profile. The concentration profiles of Ti, C, and O increase near the interface between Cu-rich zone and the matrix exhibiting no obvious overlap between Cu and O signals in Cu-rich zone, and this complments the EDS-map analysis given in Fig. 5c. Further, Fig. 6 reveals that UDD particles having an average size between 200–350 nm are dispersed within the frame-like Cu-rich region. In other words, it is likely that the starting agglomerates of UDD particles did not completely disintegrate into primary particles which have a particle size of 2–50 nm [13]. From the line-scan analysis (Fig. 6b), the thickness of Cu-rich zone can be determined as approximately 5 µm.

The fracture surfaces of the Cu15Ti/10 UDD composite broken in longitudinal and transverse direction (press) were investigated. Figure 7a shows a transverse section of Cu15Ti/10 UDD sample where the unreacted frame-like Cu-rich structure exists. These struct-
Table 1. Microhardness, density, and relative wear resistance values of the MA’d and sintered Cu15Ti matrix alloy and Cu15Ti/1 UDD and Cu15Ti/10 UDD composites

<table>
<thead>
<tr>
<th>Samples</th>
<th>ρmeasured* (g cm⁻³)</th>
<th>ρtheoretical** (g cm⁻³)</th>
<th>Relative density (%)</th>
<th>Hardness (GPa)</th>
<th>Relative wear resistance</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cu15Ti</td>
<td>5.71 ± 0.39</td>
<td>7.75</td>
<td>73.6</td>
<td>1.16 ± 0.07</td>
<td>1</td>
</tr>
<tr>
<td>Cu15Ti/1 UDD</td>
<td>5.23 ± 0.32</td>
<td>6.60</td>
<td>79.2</td>
<td>1.51 ± 0.09</td>
<td>10.43</td>
</tr>
<tr>
<td>Cu15Ti/10 UDD</td>
<td>4.42 ± 0.46</td>
<td>5.97</td>
<td>74.0</td>
<td>1.88 ± 0.11</td>
<td>2.03</td>
</tr>
</tbody>
</table>

*Density values were measured by Archimedes’ method.
**Theoretical density values were calculated based on the rule of mixture.

Table 1 also gives the relative, measured, and theoretical density values of Cu15Ti matrix alloy, Cu15Ti/1 UDD, and Cu15Ti/10 UDD composite samples as a function of UDD content. The theoretical density values for each sample were calculated using a rule of mixture. Note that density values of Cu, Ti, and UDD particles are 8.9, 4.5, and 2.7 g cm⁻³ [31], respectively. It is obvious from Table 1 that the density values of sintered samples reduced proportionally by increasing the weight percentage of UDD particles. As stated before, a number of oxide particles are changing with the weight percentage of UDD particles based on SEM/EDS analysis. Therefore, it can be suggested that the low measured densities of the Cu15Ti/1 UDD and Cu15Ti/10 UDD composites correlate well with the amount of UDD together with oxide particles. Clearly, the relative density values improved to 79.2 with the addition of UDD particles of 1 wt.% into Cu15Ti alloy, whereas the relative density values reduced to 74.0 for the further increment of UDD content (10 wt.%) in Cu15Ti alloy. This is because a large amount of oxide particles between the composite powders prevent the composite powders from sintering and this leads to low densification. Although samples were sintered under H₂ gas atmosphere for reducing the oxygen, the presence of oxide particles induced low particle-particle contact and this made sintering more difficult. Therefore, the lower densification and higher porosity level were obtained for Cu15Ti/10 UDD composite compared to Cu15Ti alloy. Cheng et al. [31] investigated the microstructural evolution of microwave sintering Cu/Ti composites reinforced with various diamond contents (10–50 vol.%). They found that the relative density of the composites increased up to 25 vol.% of diamond content and then decreased the value of 75% for the diamond content of 50 vol.% drastically, which is close to the relative density values of Cu15Ti/10 UDD composite in the present study. Poor mechanical properties and high porosity values with the addition of diamond nanoparticles (> 2 at.%) into the matrix resulting in inhomogeneous microstructure were also reported [17, 20]. The mechanical properties such as hardness and proof stress were improved in hot extruded samples containing even 20 at.% of nanodiamond particles in Cu matrix [19].
In the present study, the relative wear resistance of the composite samples was normalized by dividing the wear track area of the sintered composites by that of the unreinforced Cu15Ti matrix alloy. In other words, the wear resistance value of the unreinforced Cu15Ti matrix alloy was taken as 1. Wear track areas and the wear volume of the sintered materials were determined by using the depth \((D)\) and width \((W)\) values of wear scars measured by a profilometer. Arithmetic means of three different measurements for each sample were obtained. The measured width and depth of wear scar values are used to compute the volume by means of the following equation [6]:

\[
V = \frac{\pi}{4} W \times D,
\]

where \(V\) is the wear volume, \(W\) is the width, and \(D\) is the depth of the wear scar.

It is generally known that the wear resistance of composites containing hard reinforcement particles enhances due to the following reasons [34–36]: (a) improved hardness of the composites, (b) good interfacial bonding between matrix and reinforcement, and (c) homogeneously distributed and well bonded hard reinforcement particles which lead to a great reduction of direct load contact between the composite surface and counterface because of load bearing ability of reinforcement particles. Therefore, considering all these attributes, it is expected that the wear resistance of the sintered Cu15Ti/UDD composites increases with increasing UDD contents. However, quite contrary to the expected, the relative wear resistance of the sintered Cu15Ti/1 UDD composite sample is about 5 times higher than that of the sintered Cu15Ti/10 UDD composite sample, as seen in Table 1. Also evident from Table 1 is that the relative wear resistances of the sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composites are higher by about ten and two times than that of the Cu15Ti matrix alloy, respectively. A low relative wear resistance of the Cu15Ti/10 UDD composite sample is believed to arise from poor sintering due to the weak bonding between the matrix and the UDD particles associated with a large amount of oxygen. Similarly, Zhang and Alpas [37] reported that the detachment of the reinforcement particles from the worn surfaces shifted the wear resistance of the composites towards that of the matrix material.

SEM investigations were carried out on the worn surfaces of the sintered Cu15Ti matrix alloy, the Cu15Ti/1 UDD, and Cu15Ti/10 UDD composites. Figure 8a is a general SEM micrograph of the worn surface of the Cu15Ti matrix alloy while Fig. 8b shows a high magnification SEM image of the Cu15Ti matrix alloy revealing surface damage due to wear. Substantial amounts of the dimples and local adherent scars were observed on the worn surface of the Cu15Ti matrix alloy (Fig. 8) associated with deep grooves parallel to the sliding direction. This indicates that abrasive and adhesive wear are likely the dominant wear mechanisms of the Cu15Ti matrix alloy. Further observation of Fig. 8 suggests that there is no evidence of a transferred iron-rich layer from the steel counterface during sliding wear experiments. SEM images of the typical appearances of the worn surfaces of the sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composite samples at high and low magnifications are given in Figs. 9a,b and Figs. 9c,d, respectively. The grooves in the worn surfaces of the sintered Cu15Ti/1 UDD composite (Figs. 9a,b) are much shallower and narrower than those observed in the sintered Cu15Ti matrix alloy shown in Fig. 8. In addition, adhesive wear characteristics were identified and trace tribo-oxide layers which form due to oxide particles scattered on the worn surface can be identified in the Cu15Ti/1 UDD composite (Fig. 9b). Figures 9c,d are the SEM micrographs showing typical oxidative wear appearances taken from the worn surfaces of the Cu15Ti/10 UDD composite at low and high magnifications, respectively. The wear resistance of the sintered Cu15Ti/10 UDD composite decreased with increased amount of
the oxide phase, even when its hardness increased (Table 1). It is believed that the oxide particles in the Cu15Ti/10 UDD composite prevented particle-particle contacts and the UDD particles were removed easily from the worn surface of the sintered Cu15Ti/10 UDD. In order words, a high amount of oxide particles in the microstructure of the sintered Cu15Ti/10 UDD composite sample contributed to lower wear resistance than that of the sintered Cu15Ti/1 UDD. The presence of the oxide particles is also verified by the XRD patterns of the sintered composite samples shown in Fig. 2a, where CuO peaks exist in both the sintered Cu15Ti/1 UDD and Cu15Ti/10 UDD composites. This suggests that oxidative wear appears to be the main wear mechanism for the Cu15Ti/1 UDD and Cu15Ti/10 UDD composites. A high amount of oxide particles scattered on worn surfaces of the Cu15Ti/10 UDD composite. This may be due to delamination of the thin tribo-oxide layer as well as pulling out of UDD particles which lead to the presence of a substantial amount of oxide particles. As seen in Fig. 9d and corresponding EDS spectra (Fig. 9e) taken from a layer (indicated as A), it can be suggested that this layer comprising oxides of Fe particles was detached from the steel counterface due to the abrasive action of the UDD particles. The high oxygen concentration in the EDS analysis indicates that iron particles might be oxidized during their transfer to the surface of the sintered Cu15Ti/10 UDD composite sample.

Cheng et al. [31] reported that wear volume de-
increased very rapidly with the addition of various amounts of diamond particles (10, 20, and 25 vol.%) and it increased for the Cu/15 wt.% Ti composite containing 30–50 vol.% diamond particles due to debonding between diamond and the Cu/Ti matrix material. However, in the present study, a rather low wear resistance value was obtained with the addition of 10 wt.% of UDD particles to the Cu15Ti matrix alloy, lower than the diamond content used in Cheng et al.’s work [31]. Therefore, the lower wear resistance value was obtained with the addition of 10 wt.% of UDD particlestotheCu15Timatrixalloy,lowerthandiamondcontentusedinCheng

4. Conclusions

In the present study, Cu-15 wt.% Ti matrix alloy and its composites reinforced with 1 and 10 wt.% UDD were produced using mechanical alloying and sintering. Based on the experimental results reported in this study, the following conclusions can be drawn:

1. XRD investigations revealed the presence of the Cu, Ti, and diamond phases in the Cu15Ti/1 UDD and Cu15Ti/10 UDD composite samples. In addition to these phases, CuO phase is present in all sintered samples. Increasing UDD content improves the hardness of the sintered composites. A maximum hardness value of 1.88 GPa was measured for the Cu15Ti/10 UDD composite which is about 1.6 times higher than that of the Cu15Ti matrix alloy.

2. The line-scan and fracture surface analysis results of the Cu15Ti/10 UDD composite sample reveal that weak bonding between the diamond nanoparticles and the matrix exists probably due to the high concentration of oxygen at the particle-matrix interface.

3. Contrary to the Cu15Ti/1 UDD composite, the Cu15Ti/10 UDD composite exhibited a relatively low wear resistance due to weak bonds between matrix and UDD particles associated with oxide particles.

4. The worn surface of the Cu15Ti/10 UDD composite was completely different from that of the unreinforced Cu15Ti matrix alloy and was covered with oxide particles. EDS spectra taken from the Cu15Ti/10 UDD composite indicated that the worn surface consisted mainly of Fe and O elements detached from the counterface steel ball. This indicates that the mild oxidative wear mechanism operates during the wear test, i.e. wear proceeds mainly by the formation of an oxidative layer in the worn surface and its spalling.

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